



Product Change Notification

Change Notification #: 118276-00
Change Title: Intel® Server Chassis H2224XXLR3,
 PCN 118276-00, Label,
 Chassis and Package Regulatory Label Update
Date of Publication: May 26, 2021

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*:	Effective immediately
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is updating the Intel® Server Chassis Regulatory Common Label and the Package Label for NRTL Logo updating from 60950 to 62368.

Intel® Server Chassis Regulatory Common Label Update

Before:

After:



Package Label Update

Before:



After:



Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes but encourages customers to understand the change and determine the impact on their applications. For that reason, Intel recommends that the customer perform a standard level of evaluation

Products Affected/Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
H2224XXLR3	948907	J57870-009	J57870-010

PCN Revision History:**Date of Revision:**

May 26, 2021

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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